

VIA EFS

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re Patent Application of:	§		
Naomi OKAMOTO et al.	§		
Conf. No.:	§	Group Art Unit:	1796
1205			
Appln. No.:	§	Examiner:	H. H. Chin
10/596,757	§		
Filing Date:	§	Attorney Docket No.:	9369-120US
June 23, 2006	§		(U01-209418C/KK)

Title: PROCESS FOR PRODUCING POLYBUTADIENE
RUBBER AND RUBBER COMPOSITION

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Enclosed is a Supplemental Information Disclosure Citation Form PTO/SB/08A and/or 08B in accordance with 37 C.F.R. § 1.98(a)(1) and (a)(2) listing all patents, publications, applications, and/or other information being submitted for consideration which may be material to the patentability of this application and/or for which there may be a duty to disclose in accordance with 37 C.F.R. § 1.56. Also enclosed are copies of each of the foreign patents and/or non-patent literature documents cited therein but not copies of any U.S. patents and/or U.S. patent application publications in accordance with 37 C.F.R. § 1.98(a)(2). However, we will provide copies upon request.

The filing of this Supplemental Information Disclosure Statement shall not be construed as an admission that any of the listed documents constitutes prior art, nor as an admission against interest in any manner.

Korean Patent Application Publication Nos. 2001-111018 and 1996-34289 were first cited in an Office Action (copy enclosed along with the English translation) dated June 10, 2009 from the Korean Patent Office in counterpart Korean Application No. 7014004/2007 not more than three months prior to the filing of this Statement. U.S. Patent No. 6,664,347 B2 is being submitted as the U.S. counterpart of Korean Patent Application Publication No. 2001-111018. U.S. Patent No. 5,580,919 is being submitted as the U.S. counterpart of Korean Patent

Application Publication No. 1996-34289. We have not included Japanese Patent No. 2000-044633 (Laid-Open Patent Publication No. H12-044633) as this was cited in the Supplemental Information Disclosure Statement filed June 2, 2009.

European Patent Application Publication No. EP 1693411 A1, International Publication No. WO 2005/056663 A1, and U.S. Patent No. 4,196,406, were first cited in the August 12, 2009 European Search Report for PCT/JP2005/023379 (copy enclosed) not more than three months prior to the filing of this Statement. U.S. Patent Application Publication No. 2008/0233399 A1 is being submitted as the U.S. counterpart of International Publication No. WO 2005/056663 A1.

U.S. Patent No. 5,468,822 was first cited in the Notice of Allowance, dated August 13, 2009, of the co-pending Application No. 10/596,242 not more than three months prior to the filing of this Statement.

Applicants would like to make of record the enclosed Office Actions dated August 20, 2009 for the corresponding Canadian Application Nos. 2,591,711 of the present application and 2,591,712 of the co-pending Application No. 10/596,755.

This Information Disclosure Statement is being submitted after the mailing date of the Notice of Allowance, but before the payment of the issue fee. The Commissioner is hereby authorized to charge the amount of \$180.00 pursuant to 37 C.F.R. §1.97(c)(2) and 37 C.F.R. §1.17(p) and any deficiencies or credit any overpayments to Deposit Account No. 50-1017 (209369.0120).

It is respectfully requested that this Supplemental Information Disclosure Statement and the documents listed on the attached Form PTO/SB/08A and/or 08B be considered and

acknowledged by the Examiner in connection with the above-identified patent application, be made of record therein, and that the listed document(s) be cited in the issued patent.

Dated: *Sep. 9, 2009*

Respectfully submitted,

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Enclosures